

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>KIM TAE HEUNG</td><td>09/01/2011</td></tr><tr><td>YOON DUCK KI</td><td>09/01/2011</td></tr><tr><td>LEE KANG TAEK</td><td>09/01/2011</td></tr><tr><td>LIM HYUNG SIK</td><td>09/01/2011</td></tr><tr><td>KIM KI TAE</td><td>09/01/2011</td></tr></tbody></table>	Name	Execution Date	KIM TAE HEUNG	09/01/2011	YOON DUCK KI	09/01/2011	LEE KANG TAEK	09/01/2011	LIM HYUNG SIK	09/01/2011	KIM KI TAE	09/01/2011	
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KIM KI TAE	09/01/2011												
RECEIVING PARTY DATA													
Name:	JEONGKWAN CO., LTD												
Street Address:	4-1, Naeseok-ri, Sangbuk-myeon, Yangsan-si												
City:	Gyeongsangnam-do												
State/Country:	REPUBLIC OF KOREA												
Postal Code:	626-851												
PROPERTY NUMBERS Total: 1													
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>13225561</td></tr></tbody></table>	Property Type	Number	Application Number:	13225561									
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Application Number:	13225561												
CORRESPONDENCE DATA													
Fax Number:	(949)608-8934												
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
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Total Attachments: 3 source=Executed Assignment#page1.tif source=Executed Assignment#page2.tif source=Executed Assignment#page3.tif													

OP \$40.00 13225561

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PATENT
REEL: 026868 FRAME: 0628

ASSIGNMENT OF PATENT RIGHTS

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned:

KIM TAE HEUNG, residing at 102-1402, Shindong-a Apt., 165-1(19/5), Guseo 2-dong, Geumjeong-gu, Busan, 609-760, Republic of Korea

YOON DUCK KI, residing at 102-1205, Hanwha Ggumegreen Apt., Banyeo 1-dong, Haeundae-gu, Busan, 612-900, Republic of Korea

LEE KANG TAEK, residing at 201, Daesung Hivill, 47-4, Sajik 1-dong, Dongnae-gu, Busan, 607-817, Republic of Korea

LIM HYUNG SIK, residing at 103-1303, Hyundai 1-cha Apt., Gamman 1-dong, Nam-gu, Busan, 608-753, Republic of Korea

KIM KI TAE, residing at 464-87(16/4), Gaya 3-dong, Busanjin-gu, Busan, 614-803, Republic of Korea

have invented certain new and useful improvements disclosed in South Korean Patent Application 10-2010-0087026, filed September 6, 2010, and also in United States Patent Application No. _____, filed _____, hereby sell, assign, and transfer to:

JEONGKWAN CO., LTD

a Limited Company of the Republic of Korea, having a principal place of business at 4-1, Naeoseok-ri, Sangbuk-myeon, Yangsan-si, Gyeongsangnam-do, 626-851 ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all foreign countries, in and to any and all inventions and improvements that are disclosed in the application for the United States patent that has been executed by the undersigned prior hereto or concurrently herewith on the dates indicated below and is entitled:

**CRYSTALLIZED GLASS WITH NEGATIVE COEFFICIENT OF THERMAL
EXPANSION AND METHOD FOR MANUFACTURING THE SAME**

and in and to said application and all design, utility, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and all other patent applications that have been or shall be filed in the United States and all foreign countries of any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all foreign countries on said inventions and improvements; and in and to all rights of priority resulting from the filing of said United States and/or Patent Cooperation Treaty (PCT) application; and in all rights of priority under the International Convention for the Protection of Industrial Property for every country in the Union; agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all design, utility, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been nor will be made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Each Inventor: Please Sign and Date Below:

Date: 2011. 9. 1

Signed: 
KIM TAE HEUNG


Date: 2011. 9. 1

Signed: 
YOON DUCK KI

Date: 2011. 9. 1

Signed: 
LEE KANG TAEK

Date: 2011. 9. 1

Signed: 
LIM HYUNG SIK

Date: 2011. 9. 1

Signed: 
KIM KI TAE